

Description

The DMT69M8LSS-13 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.



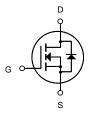
SOP-8

General Features

 $V_{DS} = 60V I_{D} = 10 A$

 $R_{DS(ON)} < 13m\Omega$ @ $V_{GS}=10V$

 $R_{DS(ON)} < 15m\Omega$ @ $V_{GS}=4.5V$



Application

Battery protection

Load switch

Uninterruptible power supply

N-Channel MOSFET

Package Marking and Ordering Information

| Product ID | Pack | Brand | Qty(PCS) |
|---------------|-------|------------|----------|
| DMT69M8LSS-13 | SOP-8 | HXY MOSFET | 3000 |

Absolute Maximum Ratings (Tc=25℃unless otherwise noted)

| Symbol | Parameter | Limit | Unit | |
|----------------------------------|--|------------|------|--|
| V _{DS} | Drain-Source Voltage | 60 | V | |
| V _G s | Gate-Source Voltage | ±20 | V | |
| I _D | Drain Current-Continuous | 10 | А | |
| I _D (100°C) | Drain Current-Continuous(Tc=100°C) | 8.5 | Α | |
| Ідм | Pulsed Drain Current | 30 | А | |
| P _D | Maximum Power Dissipation | 3 | W | |
| T _J ,T _{STG} | Operating Junction and Storage Temperature Range | -55 To 150 | °C | |



Electrical Characteristics (Tc=25°C unless otherwise noted)

| Parameter | Symbol | Condition | Min | Тур | Max | Unit |
|------------------------------------|---------------------|---|-----|------|------|------|
| Off Characteristics | | | • | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V I _D =250μA | 60 | | - | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V_{DS} =60V, V_{GS} =0V | - | - | 1 | μΑ |
| Gate-Body Leakage Current | I _{GSS} | $V_{GS}=\pm20V, V_{DS}=0V$ | - | - | ±100 | nA |
| On Characteristics (Note 3) | | | • | | | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS}=V_{GS}$, $I_{D}=250\mu A$ | 0.9 | 1.3 | 1.8 | V |
| Dunin Course On Chata Basintones | R _{DS(ON)} | V _{GS} =10V, I _D =10A | - | 10 | 13 | mΩ |
| Drain-Source On-State Resistance | | V _{GS} =4.5V, I _D =5A | - | 11.5 | 15 | mΩ |
| Forward Transconductance | G FS | V _{DS} =5V,I _D =12A | 40 | - | - | S |
| Dynamic Characteristics (Note4) | | | • | | | |
| Input Capacitance | C _{lss} | V _{DS} =30V,V _{GS} =0V, | - | 4100 | - | PF |
| Output Capacitance | Coss | | - | 298 | - | PF |
| Reverse Transfer Capacitance | C _{rss} | F=1.0MHz | - | 229 | - | PF |
| Switching Characteristics (Note 4) | | | • | | | |
| Turn-on Delay Time | t _{d(on)} | | - | 8.5 | - | nS |
| Turn-on Rise Time | t _r | V_{DD} =30V, R_L =1 Ω | - | 7 | - | nS |
| Turn-Off Delay Time | t _{d(off)} | V_{GS} =10V, R_{GEN} =3 Ω | - | 40 | - | nS |
| Turn-Off Fall Time | t _f | | - | 15 | - | nS |
| Total Gate Charge | Qg | V 20VI 40A | - | 93 | - | nC |
| Gate-Source Charge | Q _{gs} | $V_{DS}=30V,I_{D}=10A,$ | - | 9.7 | - | nC |
| Gate-Drain Charge | Q _{gd} | V _{GS} =10V | - | 20 | - | nC |
| Drain-Source Diode Characteristics | <u> </u> | | • | | | |
| Diode Forward Voltage (Note 3) | V _{SD} | V _{GS} =0V,I _S =10A | - | - | 1.2 | V |
| Diode Forward Current (Note 2) | Is | | - | - | 10 | А |
| Reverse Recovery Time | t _{rr} | $T_J = 25^{\circ}C, I_F = 10A$ | - | 32 | - | nS |
| Reverse Recovery Charge | Qrr | $di/dt = 100A/\mu s^{(Note3)}$ | - | 45 | - | nC |
| | | | | | | |

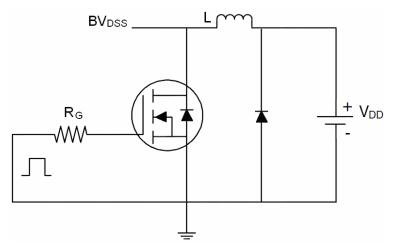
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. The value of $R_{\theta JA}$ is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The value in any given application depends on the user's specific board design.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production

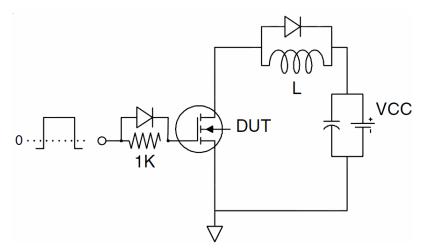


Test Circuit

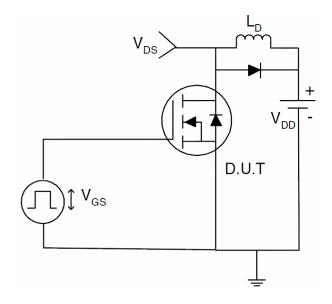
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics (Curves)

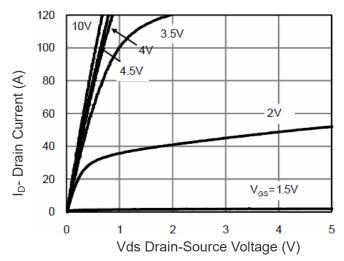


Figure 1 Output Characteristics

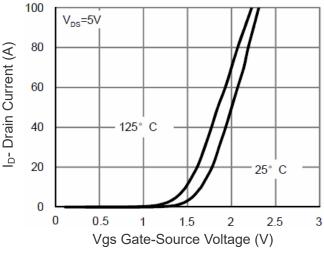


Figure 2 Transfer Characteristics

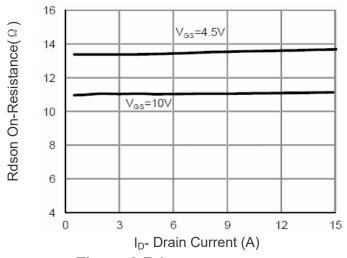


Figure 3 Rdson- Drain Current

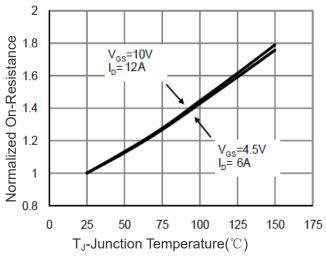


Figure 4 Rdson-JunctionTemperature

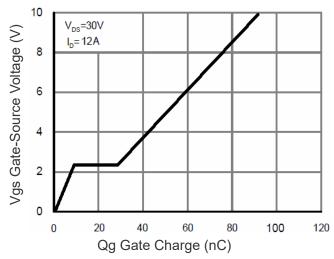


Figure 5 Gate Charge

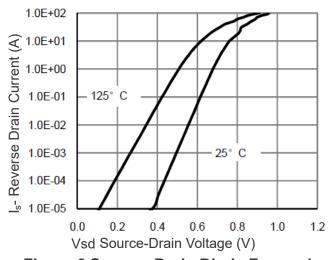
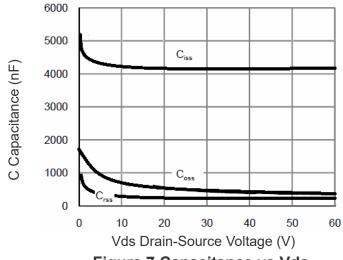


Figure 6 Source- Drain Diode Forward



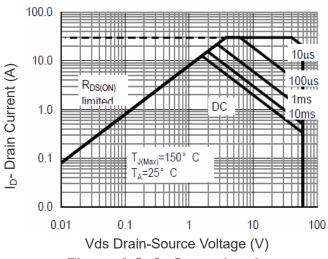


14 12 Drain Current (A) 10 8 4 2 0 25 50 100 0 75 125 150 T_J-Junction Temperature(℃)

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Figure 7 Capacitance vs Vds

Figure 9 Current De-rating



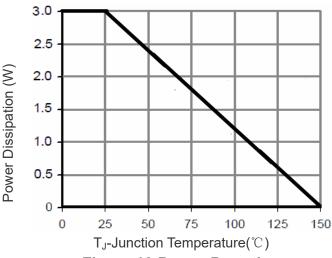
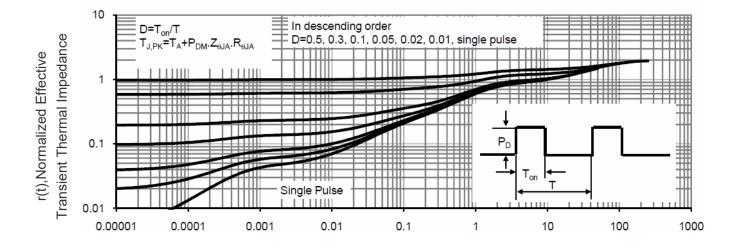


Figure 8 Safe Operation Area

Figure 10 Power De-rating

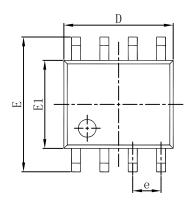


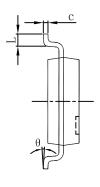
Square Wave Pluse Duration(sec)

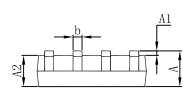
Figure 11 Normalized Maximum Transient Thermal Impedance



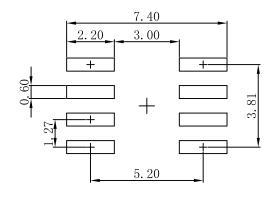
SOP-8 Package Outline Dimensions







| Symbol | Dimensions In Millimeters | | Dimensions In Inches | | |
|--------|---------------------------|--------|----------------------|--------|--|
| | Min | Max | Min | Max | |
| A | 1.350 | 1.750 | 0.053 | 0.069 | |
| A1 | 0. 100 | 0. 250 | 0.004 | 0.010 | |
| A2 | 1. 350 | 1.550 | 0.053 | 0.061 | |
| b | 0.330 | 0.510 | 0.013 | 0.020 | |
| С | 0. 170 | 0. 250 | 0.007 | 0.010 | |
| D | 4. 800 | 5. 000 | 0. 189 | 0. 197 | |
| e | 1.270 (BSC) | | 0.050 (BSC) | | |
| E | 5. 800 | 6. 200 | 0. 228 | 0. 244 | |
| E1 | 3.800 | 4. 000 | 0. 150 | 0. 157 | |
| L | 0.400 | 1. 270 | 0.016 | 0.050 | |
| θ | 0° | 8° | 0° | 8° | |



- Note: 1.Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
 3.The pad layout is for reference purposes only.



N-Channel Enhancement Mode MOSFET

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